

ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18
Stylesheet Version v18.0

Title of
Invention

HIGH PRESSURE PROCESSING CHAMBER FOR
SEMICONDUCTOR SUBSTRATE

Application Number: 09/912844
Confirmation Number: 5915
First Named Applicant: Thomas Haverstock
Attorney Docket Number:
Search string: (6521466 or 6541278 or 6546946 or 6550484
or 6558475 or 6561213 or 6561220 or 6561481
or 6561767 or 6564826 or 5217043 or
20020001929).pn.



US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
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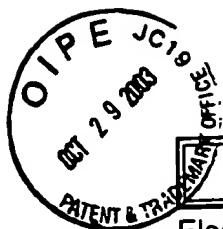
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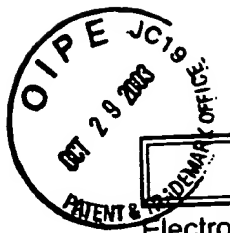
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Remarks

Note: Remarks are not for responding to an office action.

Non US Patent and Publication references shall be filed under a separate paper transmittal. The current electronic filing contains part 1 out of a total of 4 electronic filings.

Signature

Examiner Name	Date
	11-26-2003

ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention	HIGH PRESSURE PROCESSING CHAMBER FOR SEMICONDUCTOR SUBSTRATE						
Application Number:	09/912844 *09/912844*						
Confirmation Number:	5915						
First Named Applicant:	Maximilian Biberger						
Attorney Docket Number:							
Search string:	(5900107 or 5904737 or 5932100 or 5934991 or 5981399 or 5989342 or 6005226 or 6017820 or 6029371 or 6037277 or 6053348 or 6056008 or 6077053 or 6082150 or 6085935 or 6097015 or 6128830 or 6145519 or 6159295 or 6164297 or 6203582 or 6216364 or 6239038 or 6241825 or 6251250 or 6277753 or 6286231 or 6305677 or 6334266 or 6344174 or 6388317 or 6389677 or 6418956 or 6436824 or 6454945 or 6464790)pn.						
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23	6239038	2001-05-29	Wen	01
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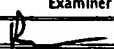
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Examiner Name	Date
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ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v1.8

Stylesheet Version v1.8.0

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Confirmation Number:	5915						
First Named Applicant:	Maximilian Riberger						
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Remarks

Note: Remarks are not for responding to an office action.

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Examiner Name	Date
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First Named Applicant:	Maximilian Silberberg						
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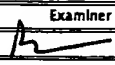
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Remarks

Note: Remarks are not for responding to an office action.

Non US Patent and Publication references shall be filed under a separate paper transmittal.
The current electronic filing contains part 1 out of a total of 4 electronic filings.

Signature

Examiner Name	Date
	11-26-03

FORM PTO-1449
(Modified)

OCT 31 2003

U.S. Department of Commerce
Patent and Trademark Office

Attorney Docket No.: SSI-00501

Serial No.: 09/912,844

INFORMATION DISCLOSURE STATEMENT BY APPLICANT
(Use Several Sheets if Necessary)

Applicants: Maximilian A. Biberger et al.

(37 CFR § 1.98(b))

Filing Date: July 24, 2001

Group Art Unit: 1763

FOREIGN PATENTS OR PUBLISHED FOREIGN PATENT APPLICATIONS

		Document Number	Publication Date	Country / Patent Office	Class	Subclass	Translation	
							Yes	No
✓	AA	CN 1399790 A	02/26/03	China	H01L	21/00		X
✓	AB	DE 36 08 783 A1	09/17/87	Germany	C30B	25/12		X
✓	AC	DE 198 60 084 A1	07/06/00	Germany	H01L	21/3213		X
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✓	AE	EP 0 272 141 A2	06/22/88	EPO	H01L	21/00		X
✓	AF	EP 0 453 867 A1	10/30/91	EPO	F16K	51/02		X
✓	AG	EP 0 572 913 A1	12/08/93	EPO	B01D	11/02		X
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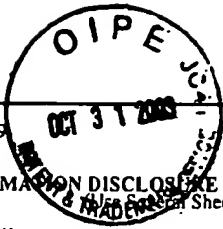
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Date Considered:

11-26-2003

EXAMINER:

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(Modified)U.S. Department of Commerce
Patent and Trademark Office

Attorney Docket No.: SSI-00501

Serial No.: 09/912,844

INFORMATION DISCLOSURE STATEMENT BY APPLICANT
(Include Foreign Sheets If Necessary)

Applicants: Maximilian A. Biberger et al.

Filing Date: July 24, 2001

Group Art Unit: 1763

(37 CFR § 1.98(b))

FOREIGN PATENTS OR PUBLISHED FOREIGN PATENT APPLICATIONS

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							Yes	No
	BJ							
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	BO							

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Ph	BQ	Sun, Y.P. et al., "Preparation of Polymer-Protected Semiconductor Nanoparticles Through the Rapid Expansion of Supercritical Fluid Solution," Chemical Physics Letters, pp. 585-588, May 22, 1998.
Ph	BR	Dahmen, N. et al., "Supercritical Fluid Extraction of Grinding and Metal Cutting Waste Contaminated with Oils," Supercritical Fluids - Extraction and Pollution Prevention, ACS Symposium Series, Vol. 670, pp. 270-279, 21 Oct 1997.
Ph	BS	Xu, C. et al., "Submicron-Sized Spherical Yttrium Oxide Based Phosphors Prepared by Supercritical CO ₂ -Assisted aerosolization and pyrolysis," Appl. Phys. Lett., Vol. 71, No.12, September 22, 1997, pp. 1643-1645.
Ph	BT	Courtecuisse, V.G. et al., "Kinetics of the Titanium Isopropoxide Decomposition in Supercritical Isopropyl Alcohol," Ind. Eng. Chem. Res., Vol. 35, No. 8, pp. 2539-2545, Aug 1996.
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Date Considered:

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